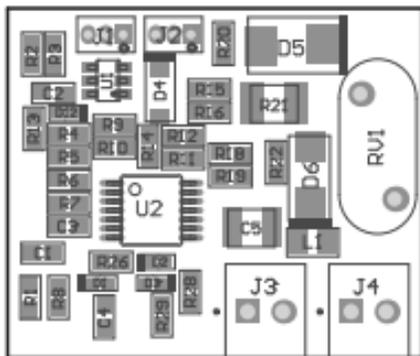
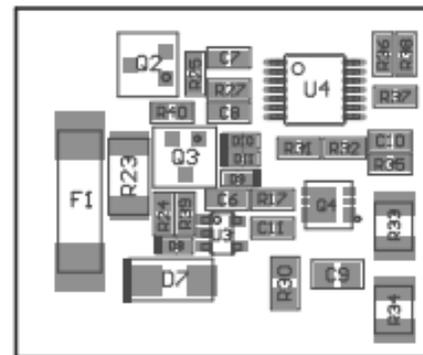


- Z21 ■ Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.
 Z22 ■ These assemblies are ESD sensitive, ESD precautions shall be observed.
 Z23 ■ These assemblies must be clean and free from flux and all contaminants. Use of no clean flux is not acceptable.
 Z24 ■ These assemblies must comply with workmanship standards IPC-A-610 Class 2, unless otherwise specified.



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-00289	REV: E2	SUN REV: Not In VersionControl
IGNORE -> ASSEMBLY TOP			
PLOT NAME = Top Assembly Drawing	GENERATED : 9/22/2014	5:41:12 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.
 ASSEMBLY VARIANT: [No Variations]

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-00289	REV: E2	SUN REV: Not In VersionControl
	IGNORE -> ASSEMBLY BOTTOM		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 9/22/2014	5:41:12 PM	TEXAS INSTRUMENTS

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